## Vishay Siliconix



## THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient <sup>a, b</sup>	t ≤ 10 s	R <sub>thJA</sub>	20	24	
Maximum Junction-to-Case (Drain Top)		R <sub>thJC</sub> (Drain)	0.8	1	°C/W
Maximum Junction-to-Case (Source) <sup>a, c</sup>	Steady State	R <sub>thJC</sub> (Source)	2.2	2.7	

Notes:

a. Surface Mounted on 1" x 1" FR4 board.

b. Maximum under Steady State conditions is 68 °C/W.

c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	-						
Drain-Source Breakdown Voltage	V <sub>DS</sub>	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$	40			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = 250 μA		45.5		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	$I_D = 250 \mu A$		- 7.1			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	1.5	2.3	3	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA	
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{DS} = 40 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$			1	μΑ	
		$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge 5 V$ , $V_{GS} = 10 V$	25			А	
Drain-Source On-State Resistance <sup>a</sup>	D	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 25 A		0.0022	0.0026	Ω	
	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 25 \text{ A}$		0.0028	0.0034		
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = 20 V, I <sub>D</sub> = 25 A		154		S	
Dynamic <sup>b</sup>			•				
Input Capacitance	C <sub>iss</sub>			8300		pF	
Output Capacitance	C <sub>oss</sub>	$V_{DS}$ = 20 V, $V_{GS}$ = 0 V, f = 1 MHz		800			
Reverse Transfer Capacitance	C <sub>rss</sub>			360			
Total Gate Charge	Qg	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 25 \text{ A}$		111	170	nC	
		V <sub>DS</sub> = 10 V, V <sub>GS</sub> = 4.5 V, I <sub>D</sub> = 20 A		52	80		
Gate-Source Charge	Q <sub>gs</sub>			25			
Gate-Drain Charge	Q <sub>gd</sub>			15			
Gate Resistance	R <sub>g</sub>	f = 1 MHz		1.15	1.7	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			50	75	- ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 20 V, $R_L$ = 2 $\Omega$		265	400		
Turn-Off Delay Time	t <sub>d(off)</sub>	$\rm I_D \cong 10$ A, $\rm V_{GEN}$ = 4.5 V, $\rm R_g$ = 1 $\Omega$		50	75		
Fall Time	t <sub>f</sub>			10	15		
Turn-On Delay Time	t <sub>d(on)</sub>			20	30		
Rise Time	t <sub>r</sub>	$\label{eq:VDD} \begin{array}{l} V_{\text{DD}} = \text{20 V}, \ R_{\text{L}} = \text{2} \ \Omega \\ I_{\text{D}} \cong \text{10 A}, \ V_{\text{GEN}} = \text{10 V}, \ R_{\text{g}} = \text{1} \ \Omega \end{array}$		15	25		
Turn-Off Delay Time	t <sub>d(off)</sub>			60	90		
Fall Time	t <sub>f</sub>			10	15		
Drain-Source Body Diode Characteristi	cs		•				
Continuous Source-Drain Diode Current	۱ <sub>S</sub>	T <sub>C</sub> = 25 °C			60	A	
Pulse Diode Forward Current <sup>a</sup>	I <sub>SM</sub>				100	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = 10 A		0.8	1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>			50	75	ns	
Body Diode Reverse Recovery Charge	Q <sub>rr</sub>	I <sub>F</sub> = 10 A, dl/dt = 100 A/μs, T <sub>.1</sub> = 25 °C		65	100	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$F = 10 \text{ A}, \text{ u/ul} = 100 \text{ A/}\mu\text{s}, T_{\text{J}} = 25 ^{\circ}\text{C}$		27		ns	
Reverse Recovery Rise Time	t <sub>b</sub>			23			

Notes:

a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

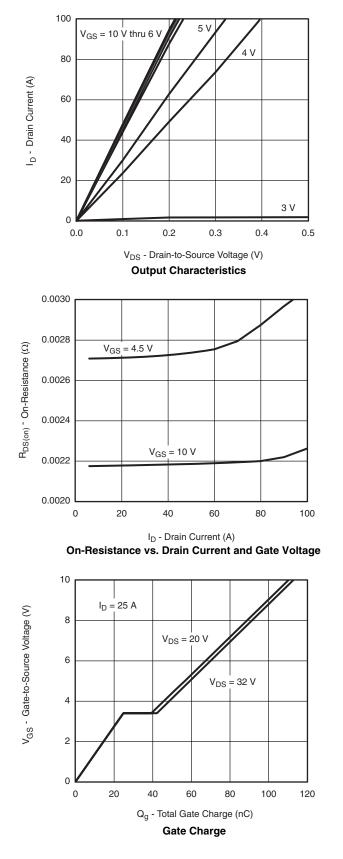
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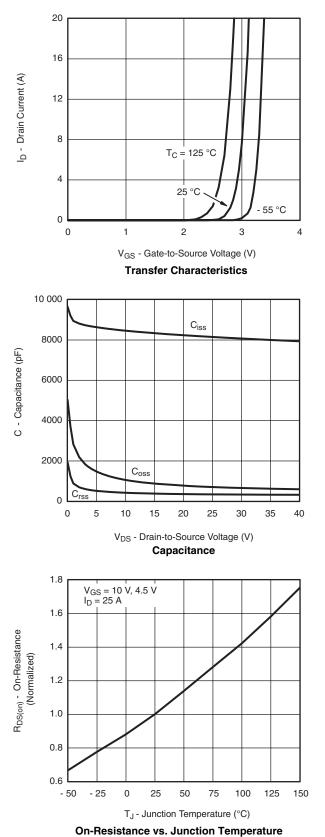


# SiE812DF

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





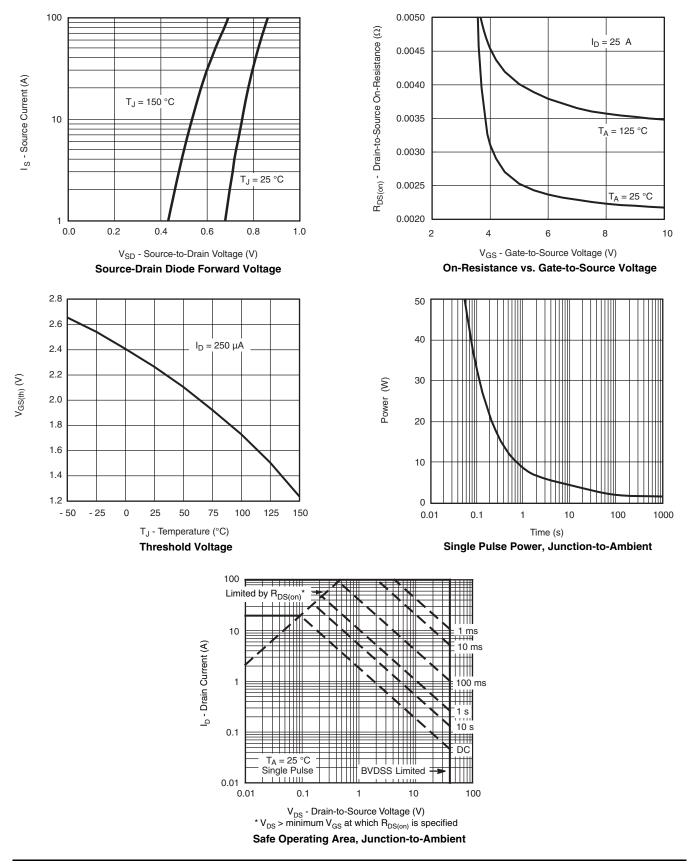
Document Number: 74337 S09-1337-Rev. B, 13-Jul-09

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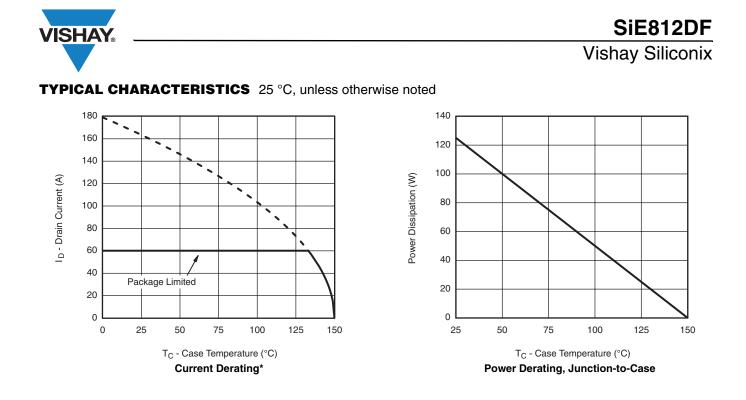
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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



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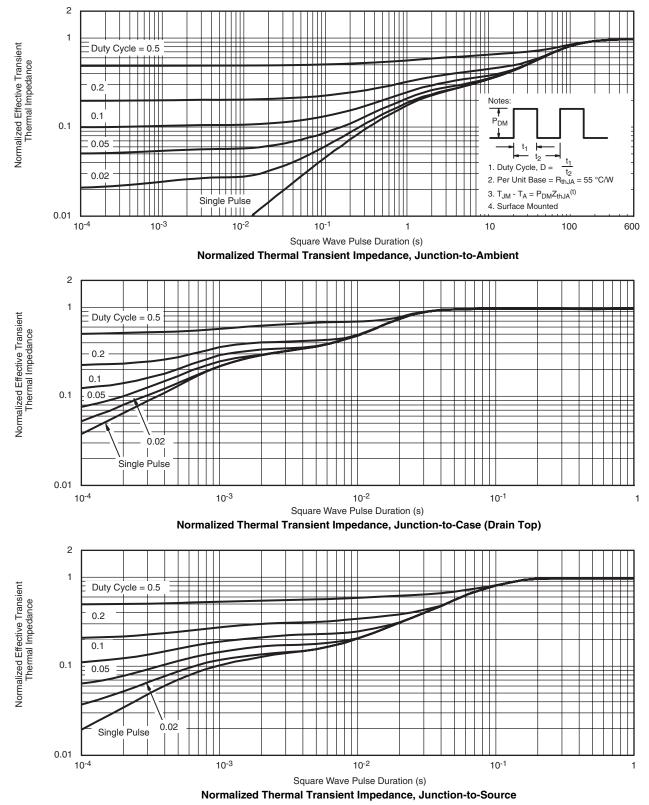


\* The power dissipation  $P_D$  is based on  $T_{J(max)} = 150$  °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="http://www.vishay.com/ppg?74337">www.vishay.com/ppg?74337</a>.

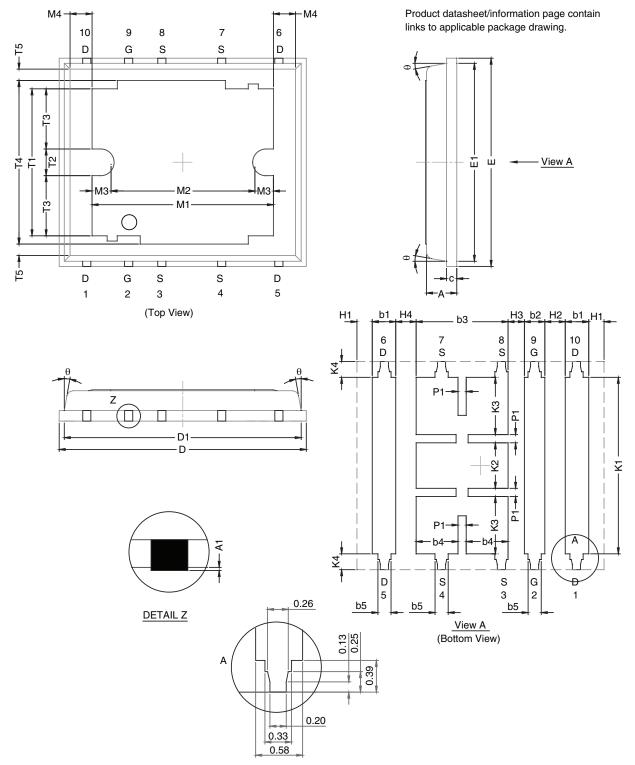
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# Package Information

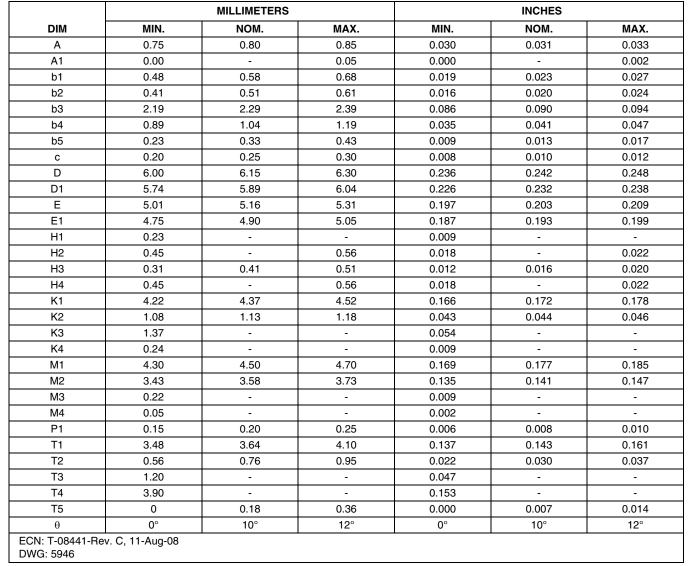
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#### **POLARPAK™ OPTION L**



# **Package Information**

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#### Notes

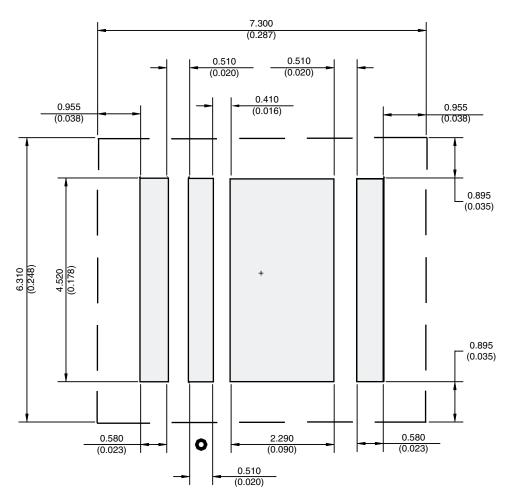
Millimeters govern over inches.



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#### RECOMMENDED MINIMUM PADS FOR PolarPAK® Option L and S



Recommended Minimum for PolarPAK Option L and S Dimensions in mm/(Inches) No External Traces within Broken Lines Dot indicates Gate Pin (Part Marking)

APPLICATION NOTE

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